
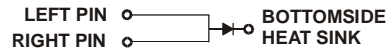
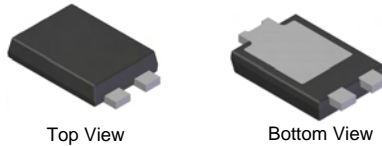


4A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER
PowerDI^{®5}
Features

- Lower Forward Voltage Drop than Ultrafast Rectifiers
- Very Low Leakage Current
- Soft Recovery Characteristics: Softness Factor (t_b/t_a) ≥ 1 (see figure 8)
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: PowerDI^{®5}
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 
- Polarity: See Diagram
- Weight: 0.095 grams (approximate)

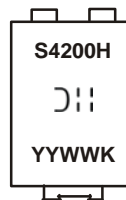



Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 2)

Part Number	Case	Packaging
PDS4200H-13	PowerDI ^{®5}	5000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*.
 2. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information


S4200H = Product type marking code
 = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last two digits of year (ex: 06 for 2006)
 WW = Week code (01 - 53)
 K = Factory Designator

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	200	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	141	V
Average Rectified Output Current (See also figure 5)	I _O	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	100	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R _{θJS}	—	3.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 3)	R _{θJA}	80	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 4)	R _{θJA}	65	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	45	—	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175		°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	200	—	—	V	I _R = 5μA
Forward Voltage	V _F	—	0.76	0.82	V	I _F = 3A, T _S = 25°C
		—	—	0.59		I _F = 3A, T _S = 150°C
		—	0.785	0.84		I _F = 4A, T _S = 25°C
		—	0.61	0.64		I _F = 4A, T _S = 150°C
		—	0.84	0.89		I _F = 8A, T _S = 25°C
		—	0.68	0.75		I _F = 8A, T _S = 150°C
Reverse Leakage Current (Note 6)	I _R	—	0.2	1	μA mA	T _S = 25°C, V _R = 200V
		—	0.8	4		T _S = 150°C, V _R = 200V
Reverse Recovery Time	t _{rr}	—	—	25	ns	I _F = 0.5A, I _R = 1.0A I _{RR} = 0.25A (see Figure 8)

- Notes:
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 - Short duration test pulse used to minimize self-heating effect.

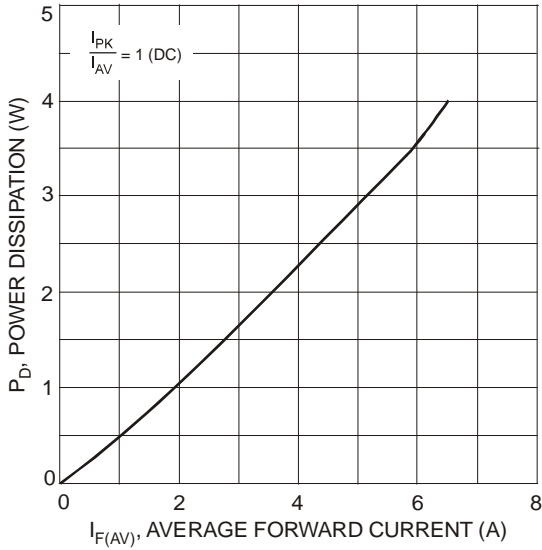


Fig. 1 Forward Power Dissipation

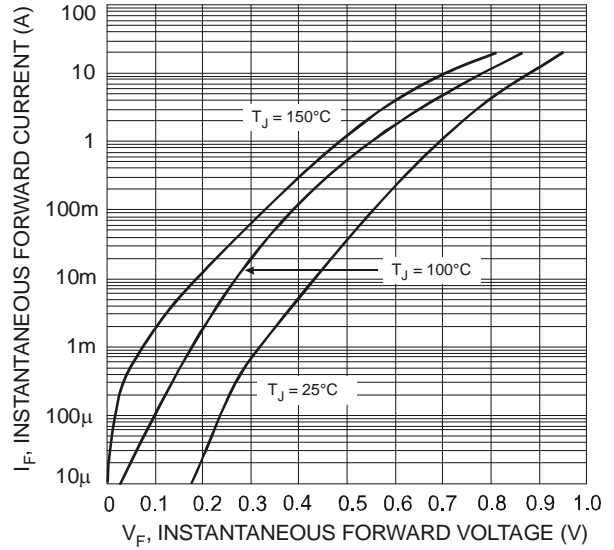


Fig. 2 Typical Forward Characteristics

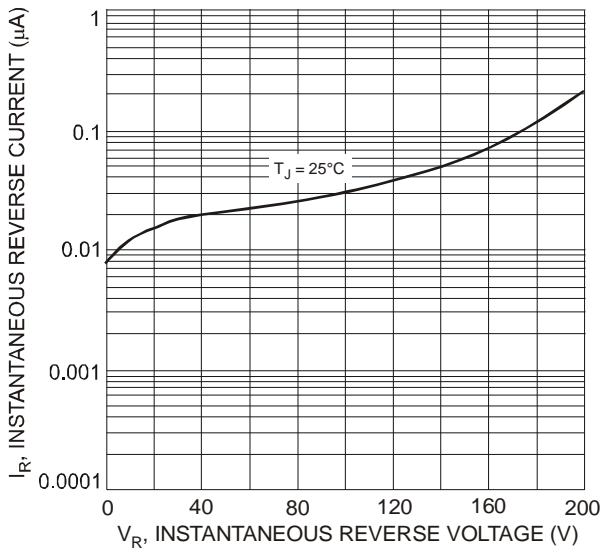


Fig. 3 Typical Reverse Characteristics

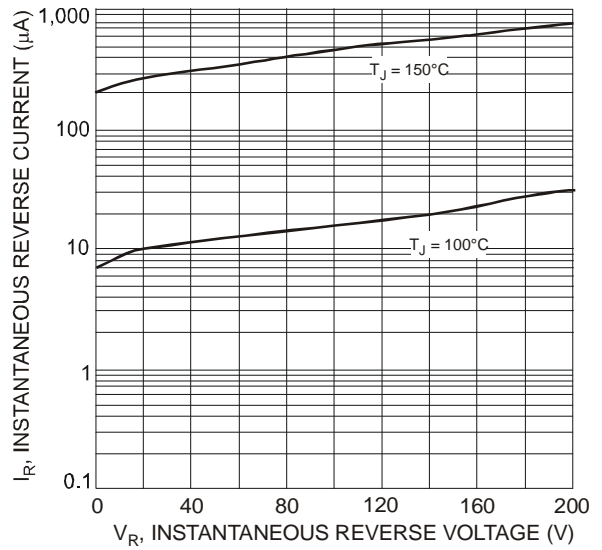


Fig. 4 Typical Reverse Characteristics

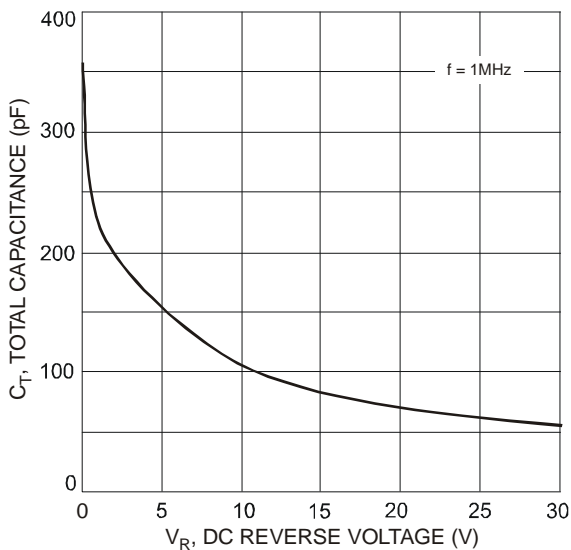


Fig. 5 Total Capacitance vs. Reverse Voltage

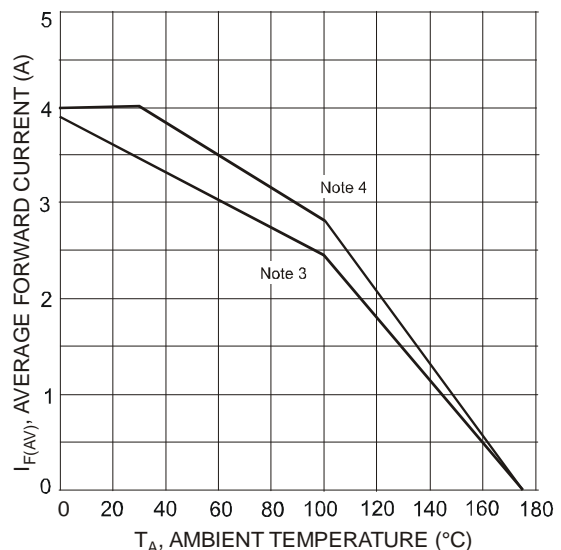


Fig. 6 Forward Current Derating Curve

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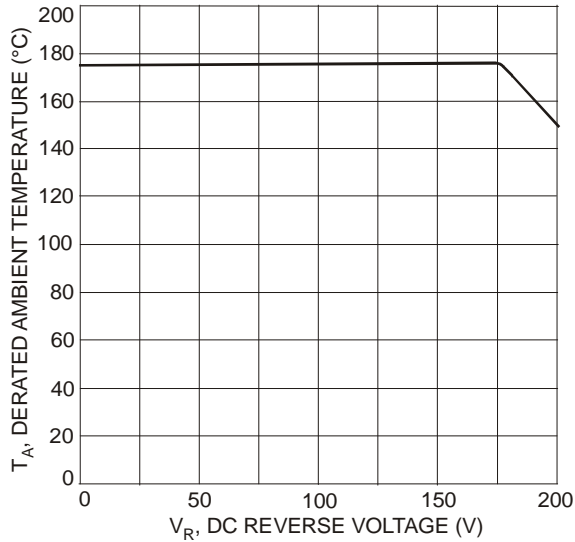


Fig. 7 Operating Temperature Derating

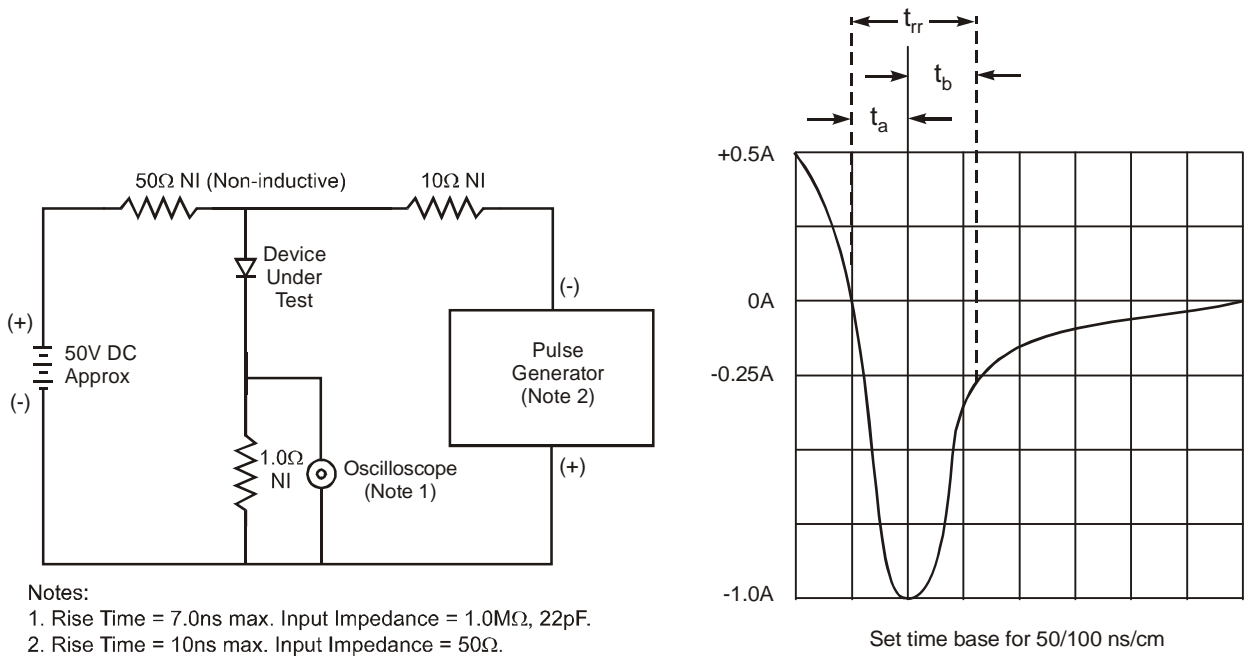
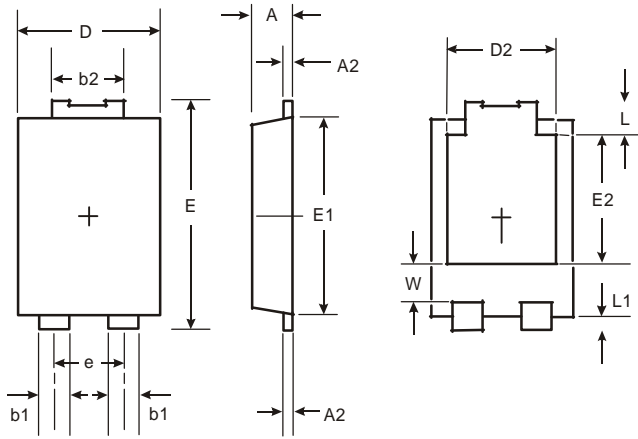


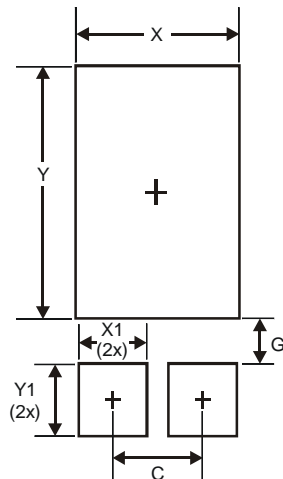
Fig. 8 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions



PowerDI ^{®5}		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400

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2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

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